TOSHIBA Bipolar Linear Integrated Circuit Silicon Monolithic

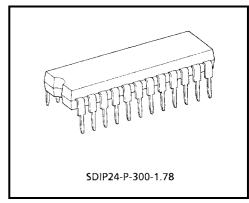
TA2092N

Power Driver IC for CD Player

The TA2092N is a power driver IC developed for CD players. This IC have built-in 4 channel BTL power amplifiers which drives focus-coil, tracking-coil for 3-beam pick-up head, disc motor and feed motor.

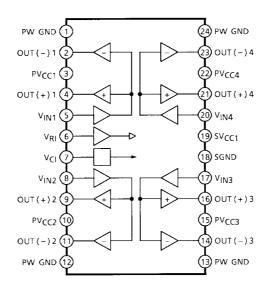
Features

- 4 channel BTL linear drivers
- Fixed voltage gain: GV = 15dB (typ.)
- High output power
 - : $V_{OM1} = 5 V_{p-p}$ (typ.) @ $V_{CC} = 5 V$, $R_L = 5 \Omega$
 - : $V_{OM2} = 6 V_{p-p}$ (typ.) @ $V_{CC} = 6 V$, $R_L = 5 \Omega$
- Thermal shutdown circuit
- Input reference voltage short protection
- Operating voltage range: V_{CC} (opr) = 4.0~10.0 V (Ta = 25°C)



Weight: 1.2 g (typ.)

Block Diagram



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Terminal Explanation

Terminal No.	Symbol	Function	Equivalent Circuit			
1 F	PW GND	Power GND Connected to substrate. pin 1, 12, 13, 24 are connected inside.	SVCC OPVCC			
2 0	OUT (−) 1	Inverted output for CH1	▼			
3	PV _{CC1}	Supply terminal of output stage for CH1 • Supply terminal of output stage are not connected to other channel terminal.	PGND			
4 0	OUT (+) 1	Non-inverted output for CH1				
5	V _{IN1}	Input for CH1 Not biased inside	SGND			
6	V_{RI}	Input reference voltage • Under condition of V _{RI} ≤ 1.8 V, internal bias circuit is shut off. • No signal input condition: V _{RI} = V _{IN}	30k \(\text{39k \(\text{1} \)			
7	V _{CI}	Output reference voltage • V _{OUT} = V _{CI} = (V _{CC} -V _F) /2	ODN SS A STAND STAND SS A STAND SS A STAND SS A STAND STAND SS A S			
8	V _{IN2}	Input for CH2				
9 C	OUT (+) 2	Non-inverted output for CH2				
10	PV _{CC2}	Supply terminal of output stage for CH2	Same as channel 1			
11 C	OUT (−) 2	Inverted output for CH2				
12 F	PW GND	Power GND				
13 F	PW GND	Power GND				
14 C	OUT (−) 3	Inverted output for CH3				
15	PV _{CC3}	Supply terminal of output stage for CH3	Same as channel 1			
16 C	OUT (+) 3	Non-inverted output for CH3				
17	V _{IN3}	Input for CH3				
18	S GND	Supply terminal of small signal GND	_			
19	S V _{CC}	Small signal GND	_			
20	V _{IN4}	Input for CH4				
21 C	OUT (+) 4	Non-inverted output for CH4				
22	PV _{CC4}	Supply terminal of output stage for CH4	Same as channel 1			
	OUT (−) 4					

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	14	V
Power dissipation	P _D (Note 1)	(2) (Note 2)	W
Operating temperature	T _{opr}	-30~85	°C
Storage temperature	T _{stg}	-55~150	°C

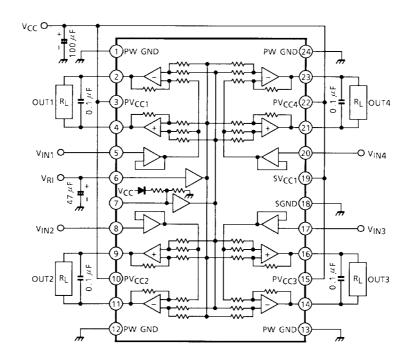
Note 1: Mounted on 50 mm \times 50 mm \times 1.6 mm size board with copper area 60 % over.

Note 2: Derated above $Ta = 25^{\circ}C$, in the proportion of 62.5 mW/°C.

Electrical Characteristics (unless otherwise specified, V_{CC} = 5 V, R_L = 5 Ω , R_g = 620 Ω , V_{RI} = 2.1 V, f = 1 kHz, Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Operating voltage	V _{CC}	_	_	4.0	_	10.0	V	
Quiescent current	Iccq	_	V _{in} = 0, R _L = OPEN	20	35	60	mA	
Input offset current	I _{IN}	_	V _{IN} = 2.1 V	_	250	800	nA	
V _{RI} terminal offset current	I ₁₀	_	V _{RI} = 2.1 V	_	35	120	μΑ	
	V _{O OS1}	_	V_{CC} = 5 V, R_g = 0 Ω	-30	_	30		
Output offset voltage	V _{O OS2}	_	V_{CC} = 8 V, R_g = 0 Ω	-50	_	50	mV	
	V _{O OS3}	_	V_{CC} = 12 V, R_g = 0 Ω	-100	_	100		
Reference output voltage	V _{OUT}	_	_	_	2.1	_	V	
Maximum output voltage	V _{OM1}	_	V _{CC} = 5 V	4.0	5.0	_	V _{p-p}	
waximum output voltage	V _{OM2}	_	V _{CC} = 6 V	5.0	6.0	_		
Voltage gain	G _V	_	V _{in} = 100 mVrms	14.5	15.5	16.5	dB	
Frequency response	f _C	_	V _{in} = 100 mVrms	_	100	_	kHz	
Total harmonic distortion	THD	_	V _{in} = 100 mVrms	_	-50	_	dB	
Slew rate	S.R.	_	V _{out} = 2 V _{p-p}	-	1.0	_	V/µs	
Cross talk	C.T.	_	V _{out} = 1 Vrms	-	-60	_	dB	
Ripple rejection ratio	R.R.	_	f _{rip} = 100 Hz, V _{rip} = 100 mVrms	_	-60	_	dB	
Thermal shut down temperature	T _{TSD}	_	Chip temperature	_	150	_	°C	
V _{RI} ~GND short protection voltage	V _{RI OFF}	_	_	1.4	1.6	1.8	V	

Test Circuit



Precaution Use

- Input stage
 - Input stages are consisted of differential circuit of NPN Tr, and have built-in IB compensation circuit.
- Built-in driver
 - Each channel driver consists of BTL configuration linear amplifier.
 - Voltage gain is fixed: GV = 15.5 dB (typ.)
 - Voltage loss for output stage is 2 VBE = VCE (sat) for positive cycle, VCE (sat) for negative cycle, because of no-bootstrap circuit. So, output DC voltage is designed as less than 1/2 VCC.
- VRI terminal
 - VRI is reference voltage terminal for input signal.

If reference voltage from servo IC drop less than 1.8 V, protection circuit operates and shut off bias circuit inside. This operation is to prevent load from moving undesireably in case of $V_{\rm RI}$ drop for accident or some reason.

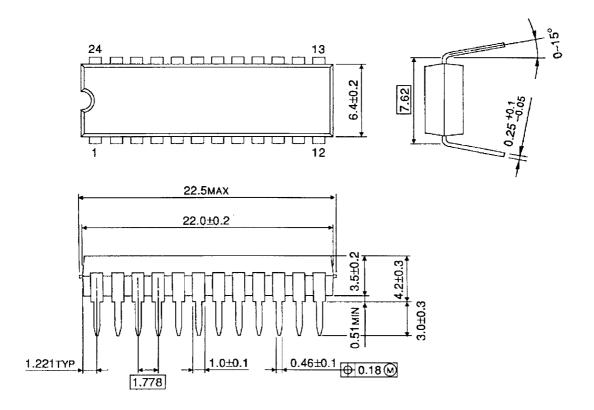
- VCI terminal
 - Output DC voltage is determined by circuit of this terminal inside as;
 - $V_{CI} = V_{OUT} (DC) = (V_{CC} V_F) / 2$
 - Output signal dynamic range is depend on VCC. On the other hand, input signal dynamic range is determined by VRI as mentioned and voltage gain is fixed inside. So, maximum output voltage does not increase as VCC increases.
 - Because of BTL configuration, Ripple Rejection Ratio does not improve not much when capacitor is connected to VCI terminal to GND.
- GND
 - Large signal GND is for output stage and small signal GND is for stages from input circuit to pre-output stage.
 - These GND pins are not connected inside.
 - The heat of power dissipation is transferred to PCB, through these PW-GND Pin, because, 1, 12, 13, 24 pin are connected each other and to substrate of Pellet to connected copper foil area as large as possible.
- Oscillation preventive capacitor
 - We recommend to use the capacitor of $0.1~\mu F$, between each output terminals. But perform the temperature test to check the oscillation allowance, since the oscillation allowance is varied according to the causes described below.
 - 1) Supply voltage
 - 2) Ambient temperature
 - 3) Load impedance
 - 4) Capacity value of condenser
 - 5) Kind of condenser
 - 6) Layout of Printed board
- We recommend to connect Pass-condenser, which is about 10 to 100 μF between V_{RI} terminal and GND.
- VCI terminal is recommend to use "OPEN".

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Package Dimensions

SDIP24-P-300-1.78 Unit: mm



Weight: 1.2 g (typ.)

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